Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

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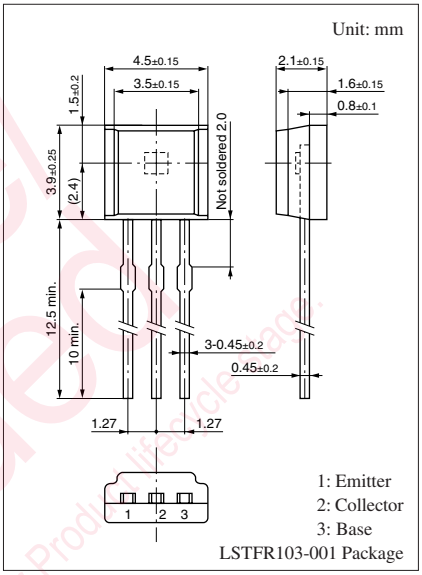
PNA1605F (PN116)

Silicon planar type

For optical control systems



■ Features

- High sensitivity
- Wide directivity characteristics, suited for detecting GaAs LEDs: θ = 70° (typ.)
- Fast response: t_r , t_f = 8 µs (typ.)
- Side-view type package

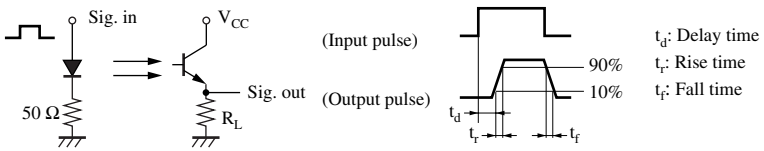
■ Absolute Maximum Ratings $T_a = 25°C$

Parameter	Symbol	Rating	Unit
Collector-emitter voltage (Base open)	V_{CEO}	20	V
Collector-base voltage (Emitter open)	V_{CBO}	30	V
Emitter-collector voltage (Base open)	V_{ECO}	5	V
Emitter-base voltage (Collector open)	V_{EBO}	5	V
Collector current	I_C	10	mA
Collector power dissipation	P_C	100	mW
Operating ambient temperature	T_{opr}	−25 to +85	°C
Storage temperature	T_{stg}	−30 to +100	°C

■ Electrical-Optical Characteristics $T_a = 25°C \pm 3°C$

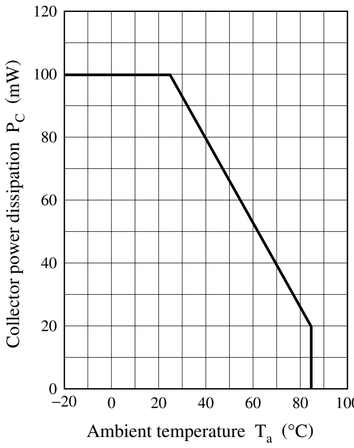
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Photocurrent *1	$I_{CE(L)}$	V_{CE} = 10 V, L = 100 lx	0.2	0.8		mA
Dark current	I_{CEO}	V_{CE} = 10 V		0.05	2.00	µA
Peak emission wavelength	λ_p	V_{CE} = 10 V		900		nm
Half-power angle	θ	The angle from which photocurrent becomes 50%		70		°
Rise time *2	t_r	V_{CC} = 10 V, $I_{CE(L)}$ = 1 mA, R_L = 100 Ω		8		µs
Fall time *2	t_f			9		µs
Collector-emitter saturation voltage *1	$V_{CE(sat)}$	$I_{CE(L)}$ = 1 mA, L = 1 000 lx		0.3	0.6	V

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.
2. *1: Source: Tungsten (color temperature 2 856 K)
*2: Switching time measurement circuit

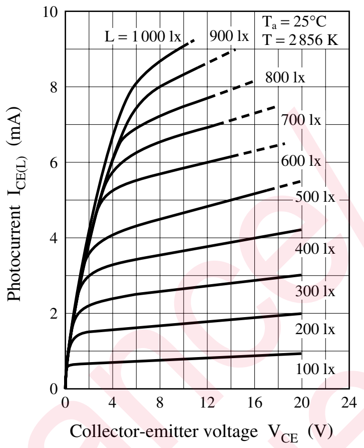


Note) The part number in the parenthesis shows conventional part number.

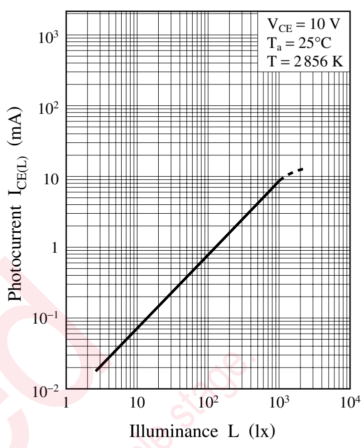
P_C — T_a



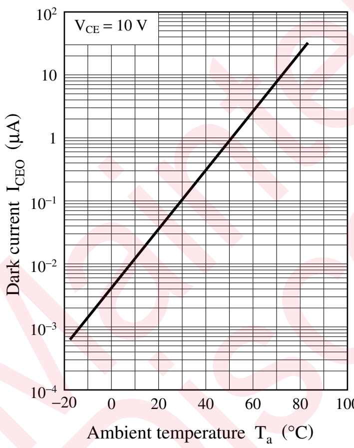
$I_{CE(L)}$ — V_{CE}



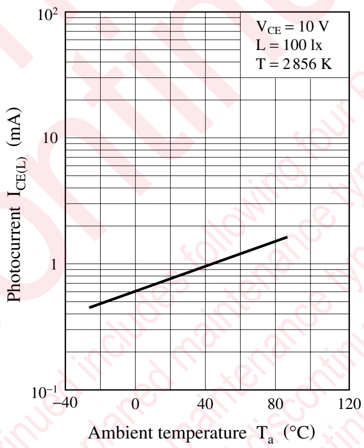
$I_{CE(L)}$ — L



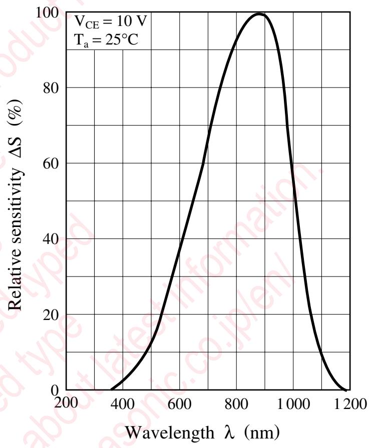
I_{CEO} — T_a



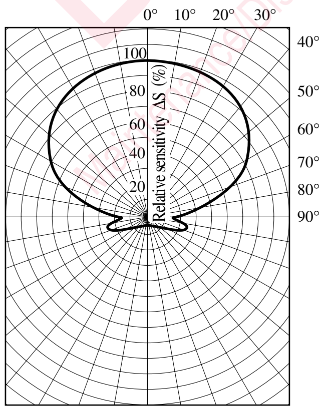
$I_{CE(L)}$ — T_a



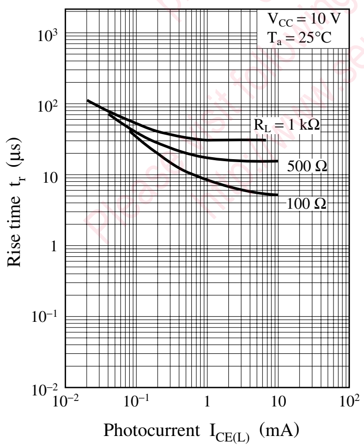
Spectral sensitivity characteristics



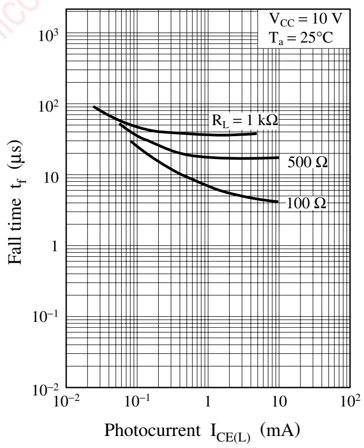
Directivity characteristics



t_r — $I_{CE(L)}$



t_f — $I_{CE(L)}$



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